



# Comparison of nBn and nBp mid-wave barrier infrared photodetectors

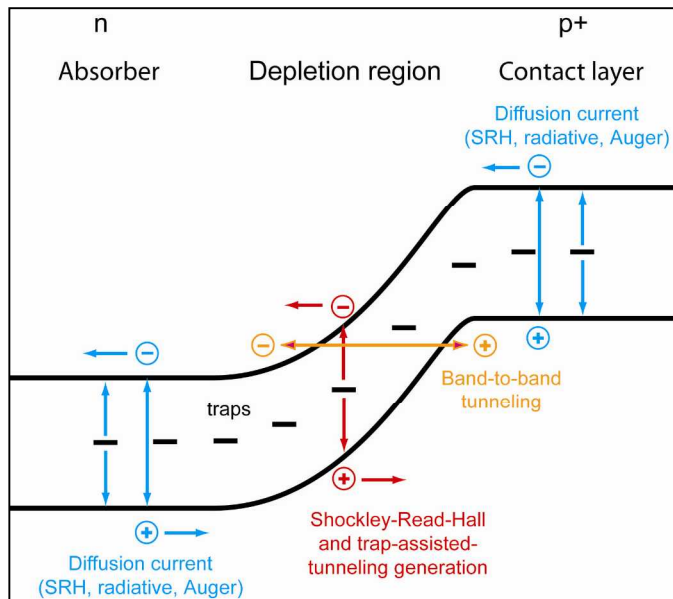
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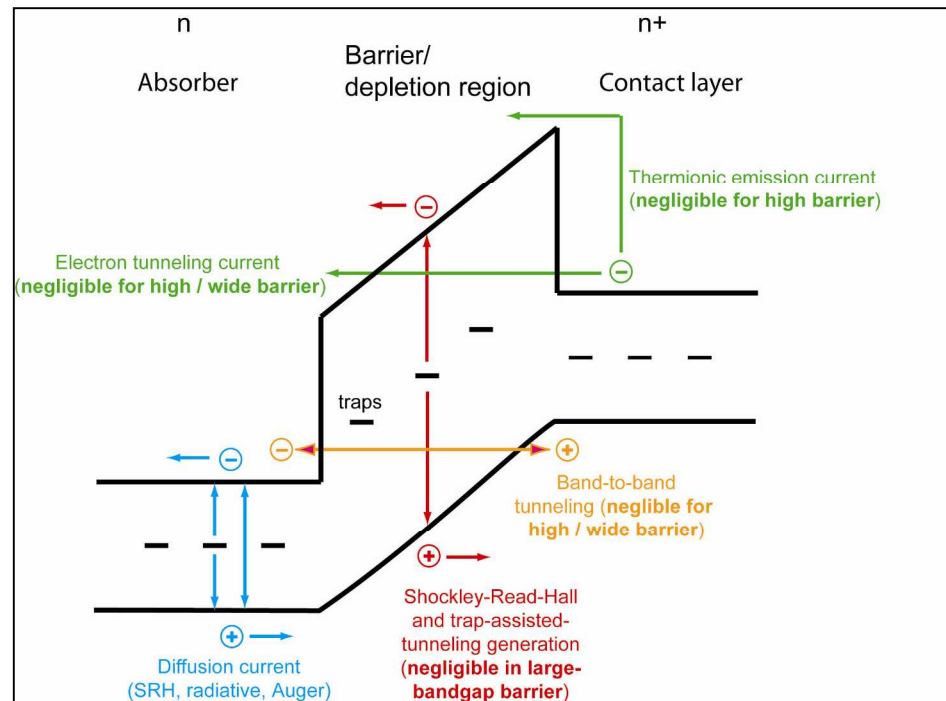
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# Intrinsic dark current sources in p-n and nBn detectors

## Conventional p-n homojunction



## *Idealized* nBn structure



- Idealized nBn structure eliminates dark current from all sources except generation processes that produce absorber diffusion current
- Elimination of depletion region SRH generation may greatly reduce dark current at lower temperatures (where depletion region SRH dominates in conventional p-n)

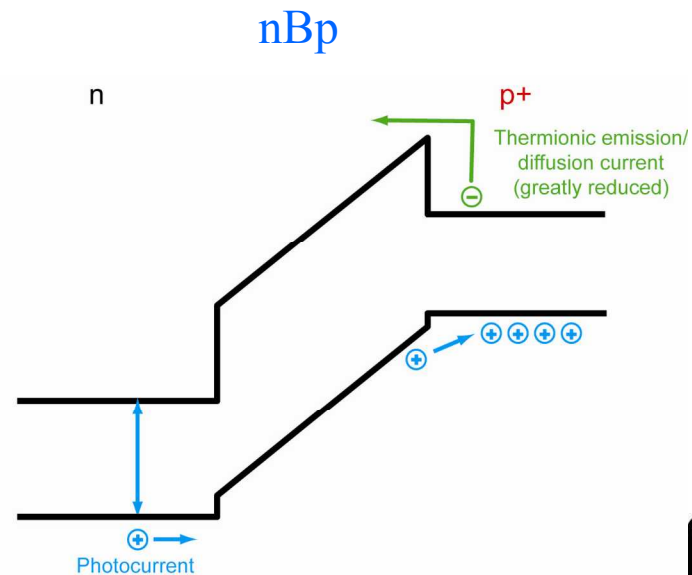
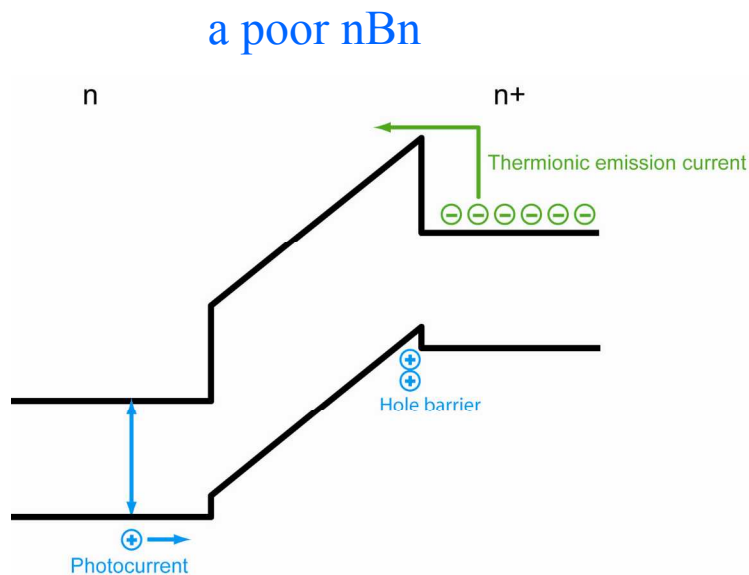
# Why examine nBp structures?

nBn structure relies on a very special case with zero VB discontinuity and large CB discontinuity between absorber and barrier. In more general case:

- VB discontinuity produces undesirable hole barrier, or
- Smaller CB discontinuity (or high temperature) results in electron thermionic emission current

nBp structure allows substantially greater flexibility in material choices

- p contact material need not be same as absorber
- p doping reduces thermionic emission dark current
- Also exhibits high responsivity at zero bias



# Goals and Methods

- Examine and compare characteristics of similar mid-wave nBn and nBp devices  
Devices nominally identical except for doping of contact layer
- Perform numerical simulation to understand nBn and nBp performance
- Extract material properties relevant to device performance

- Experimental comparison limited to unoptimized structures

*Changes to structures will significantly alter this comparison*

- Device structure

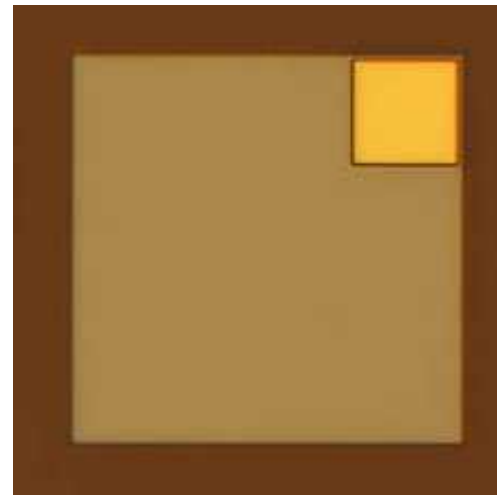
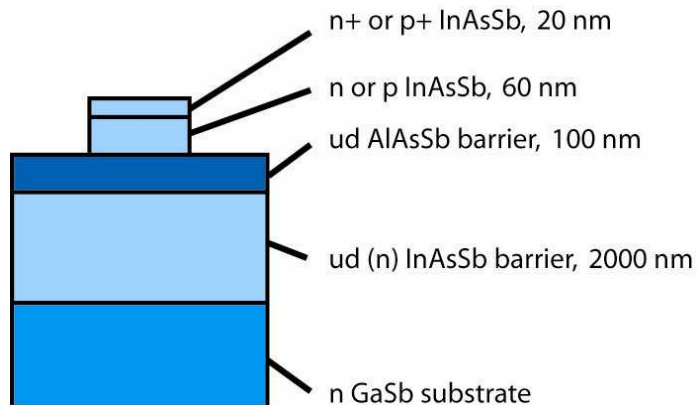
Absorber InAsSb nearly lattice-matched to GaSb, not intentionally doped

Barrier AlAsSb nearly lattice-matched to GaSb, not intentionally doped

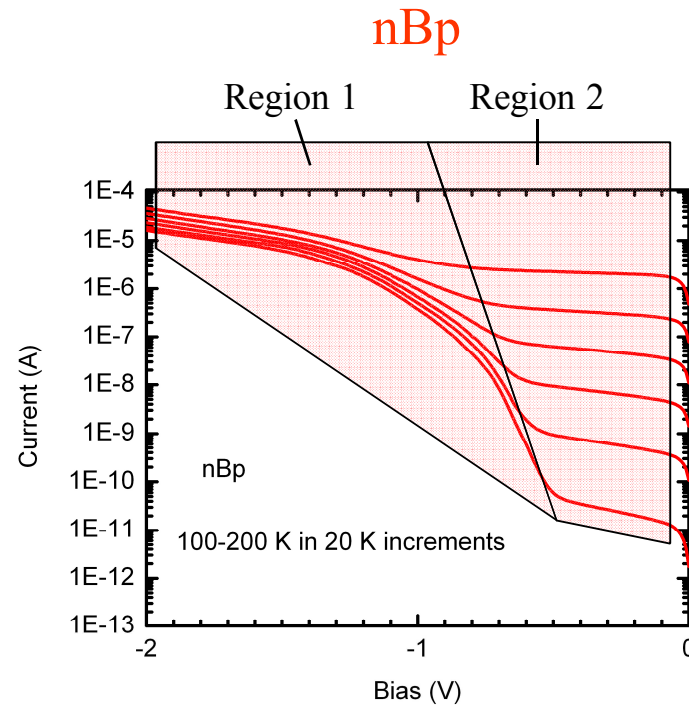
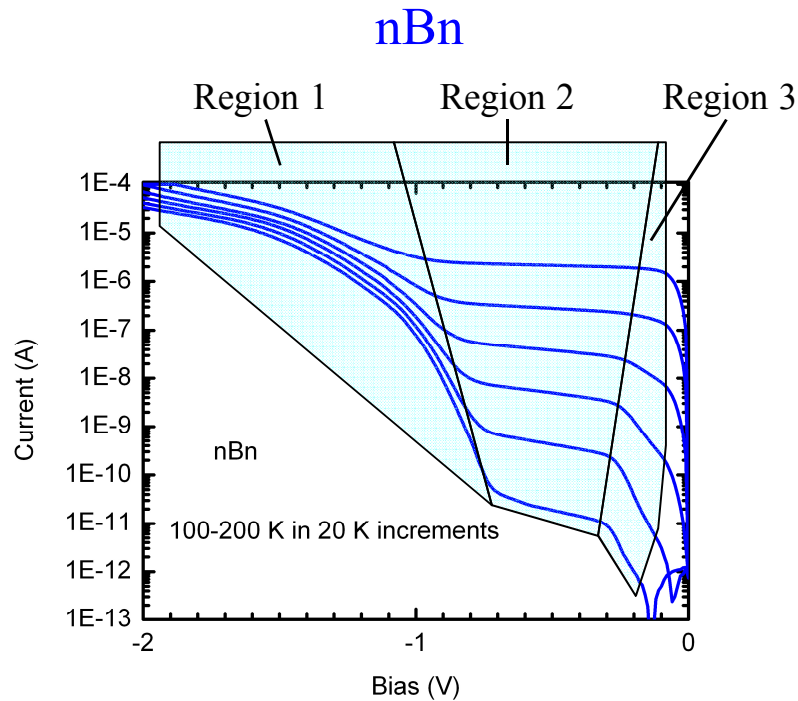
Contact layer InAsSb, either Si-doped (nBn) or Be-doped (nBp)

Absorber bandgap  $\sim 4.2 \mu\text{m}$  (at 200 K)

Large-area devices ( $500 \times 500 \mu\text{m}^2$ )



# Detector dark I-V characteristics

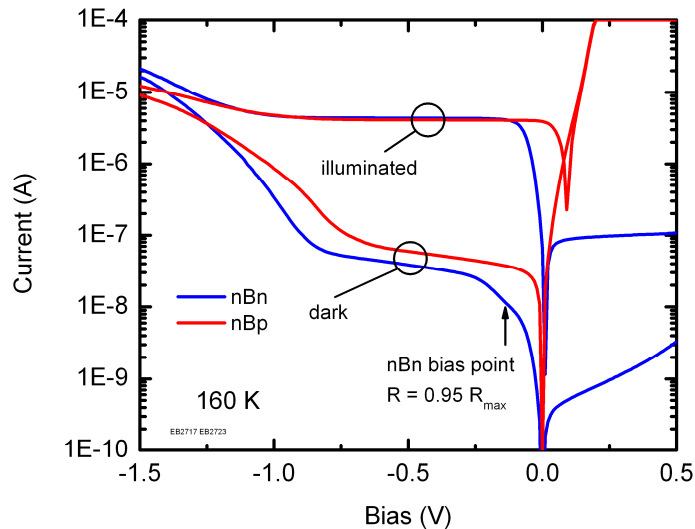


Region	T dependence	Bias dependence
1	weak	strong
2	strong	weak
3	strong	strong

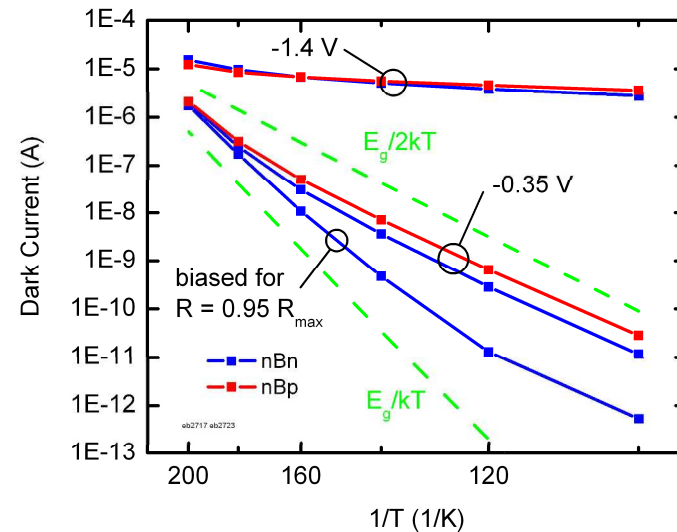
- nBn has nonzero I at zero bias (low T)  
absence in nBp suggests e- trapping
- nBp has no Region 3

# Comparison of dark and illuminated I-Vs

I-V at 160 K



Dark I vs. T

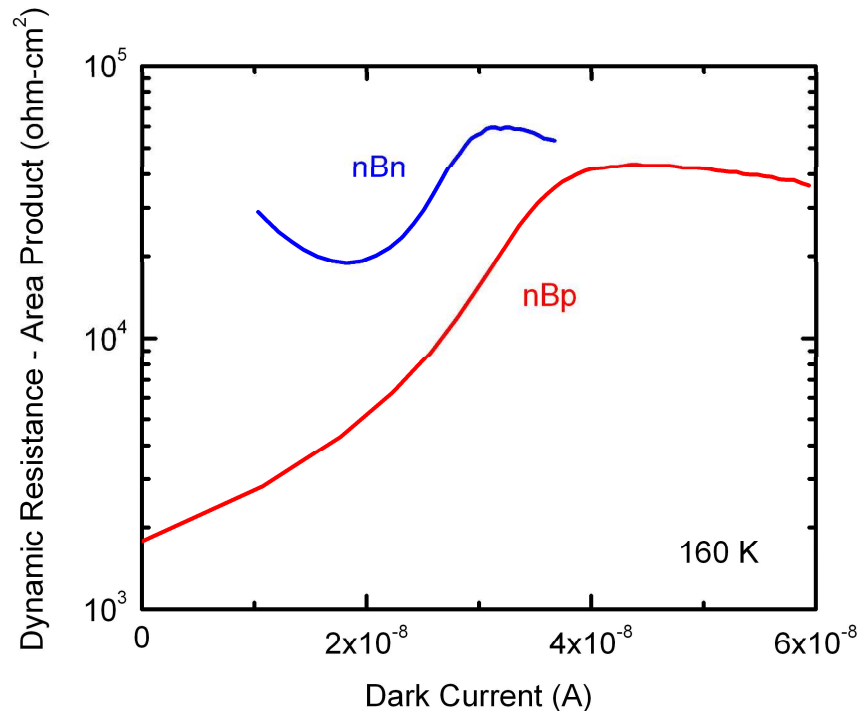


" $E_g/2kT$ " means  $\sim T^{3/2} \exp(-E_g(T)/2kT)$

- nBp lacks Region 3 ("shoulder")
- Similar maximum responsivities
- nBn requires significant bias for max responsivity
- nBn dark currents generally slightly less than nBp
- nBn achieves max responsivity in shoulder region

- Region 1 has little temperature dependence  
→ tunneling
- Region 2 has  $E_g/2kT$  dependence  
→ depletion region Shockley-Read-Hall
- nBn biased at  $0.95 R_{max}$  has  $E_g/kT$  dependence  
→ diffusion current

# Comparison of dynamic resistance



Shown only for biases with responsivity  $\geq 95\%$  of maximum responsivity

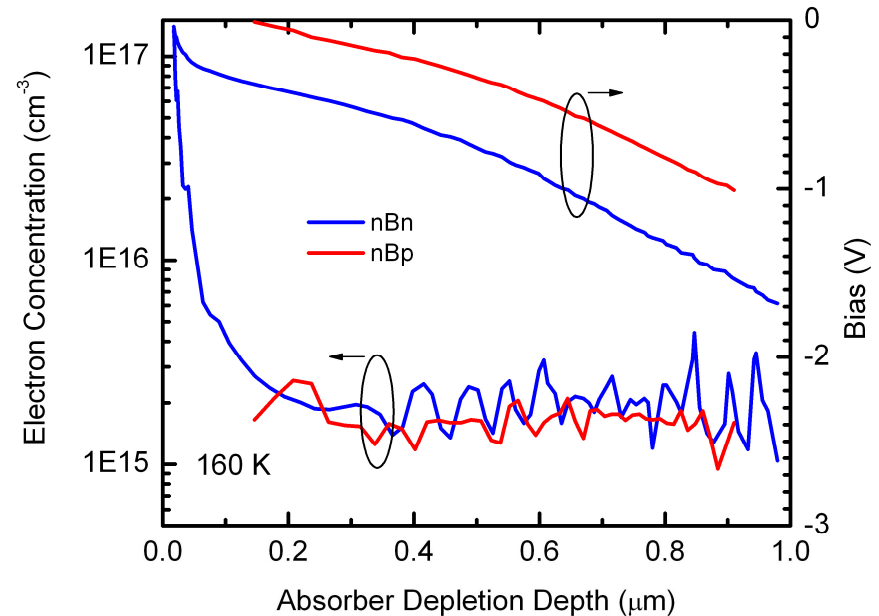
For any given dark current, nBn has higher dynamic resistance

- Suggests that lower dark current of nBp at low bias offset by higher Johnson noise

# Capacitance-voltage measurements

$$C = \frac{C_{abs} C_{bar}}{C_{abs} + C_{bar}} \quad n = -\frac{2}{A^2 q \epsilon_0 \epsilon_{abs}} \frac{dV}{d(1/c^2)}$$

- InAsSb absorber is n-type  $\sim 2 \times 10^{15} \text{ cm}^{-3}$
- Zero-bias absorber depletion depths
  - nBn**  $\sim 0 \text{ } \mu\text{m}$  – **accumulation** layer
  - nBp**  $0.15 \text{ } \mu\text{m}$  – large built-in potential
- Absorber depletion depths with bias  $-0.35 \text{ V}$ 
  - nBn**  $0.11 \text{ } \mu\text{m}$
  - nBp**  $0.51 \text{ } \mu\text{m}$



- nBn electron accumulation layer is depleted with bias  $\sim 0.3 \text{ V}$ 
  - Coincides with boundary between I-V regions 2 and 3
  - Suggests reduction of dark current in Region 3 related to existence of accumulation layer
- Existence of accumulation layer implies absence of depletion region SRH generation
- nBp has no accumulation layer because of larger built-in potential
  - nBp will have significant depletion region SRH at any reverse bias





# Finite element numerical analysis

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- Commercial device simulator with temperature-dependent material parameters
- Drift-diffusion approximation, with thermionic barrier boundary conditions at higher T
- Generation/recombination mechanisms in absorber
  - Radiative
  - Shockley-Read-Hall
  - Trap-assisted tunneling (electric field enhancement to SRH)
  - Auger
- Generation/recombination assumed negligible in barrier
- Absorber/barrier VB discontinuity assumed to be zero
- Strain and quantum confinement effects ignored
- Doping as intended or as measured by C-V. Barrier assumed n-type  $4 \times 10^{15} \text{ cm}^{-3}$
- InAsSb SRH lifetime assumed to be 500 ns
- Contact minority carrier generation suppressed by including additional barriers
- Simulation restricted to  $|\text{bias}| < 0.6 \text{ V}$



## Approximate expressions for dark current generation rates

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In **neutral absorber**, where holes are strongly extracted by reverse bias  
(  $np \ll n_i^2$  , and  $n \gg n_i$  )

$$\begin{aligned} G_{SRH} &= n_i^2 / (\tau_p n) && \text{(SRH)} \\ G_{Rad} &= C_R n_i^2 && \text{(Radiative)} \\ G_{Aug} &= C_n n_i^2 n && \text{(Auger)} \end{aligned}$$

In **absorber depletion region**, where both holes and electrons are extracted  
(  $n \ll n_i$  and  $p \ll n_i$  )

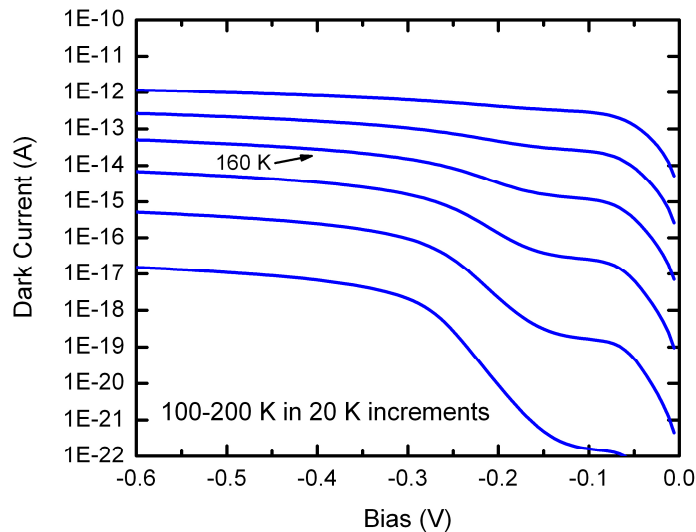
$$\begin{aligned} G_{SRH} &= n_i / (\tau_p + \tau_n) && \text{(SRH)} \\ G_{Rad} &= C_R n_i^2 && \text{(Radiative)} \\ G_{Aug} &= 0 && \text{(Auger)} \end{aligned}$$

SRH (either in neutral absorber or depletion region)  
dominates generation in these devices from 100-200 K

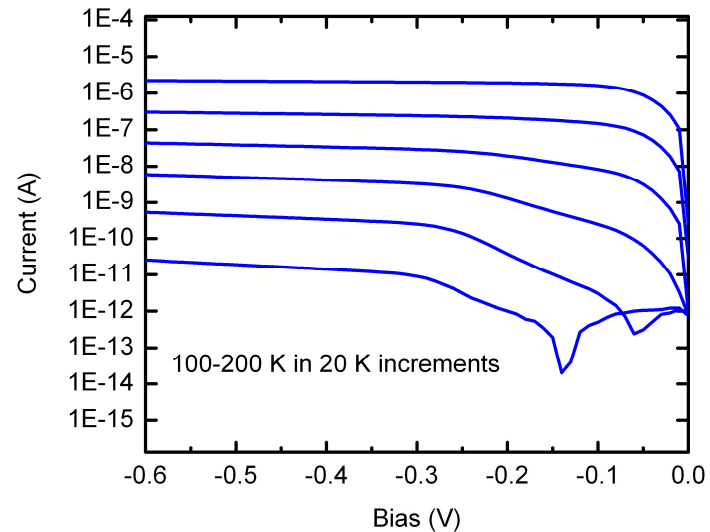
$$\frac{SRH_{depl}}{SRH_{neut}} \sim \frac{N_{abs}}{n_i} \frac{D_{depl}}{D_{neut}} \frac{\tau_p}{(\tau_p + \tau_n)}$$

## Comparison of simulated and measured nBn characteristics

Simulated ( $1 \times 0.2 \mu\text{m}^2$  device)



Measured ( $500 \times 500 \mu\text{m}^2$  device)

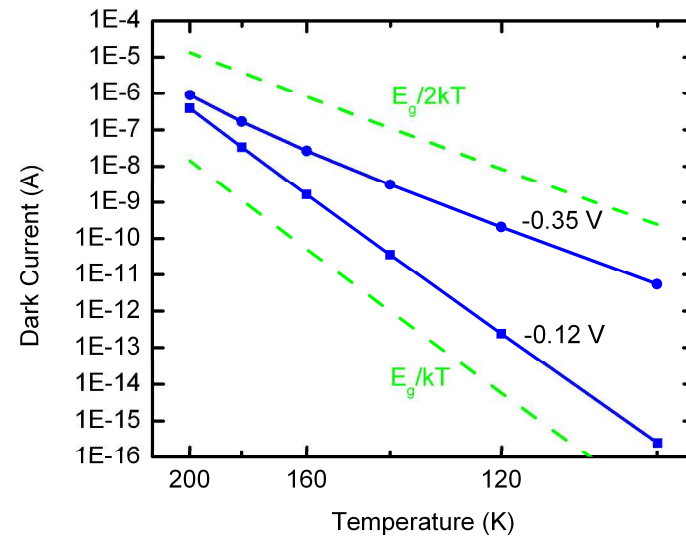
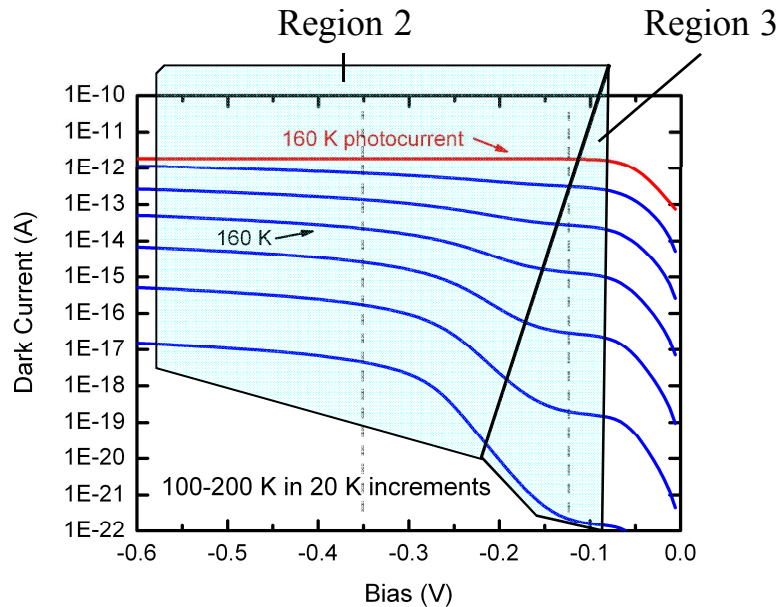


Differences between simulation and experiment may be due to

- Uncertainty in barrier doping and traps
- Residual absorber/barrier VB discontinuity
- Measurement current floor
- Uncertainty in Auger and radiative coefficients (higher T)
- Temperature-dependent SRH lifetime

Depletion region SRH current implies SRH lifetime 600 ns

# Simulated nBn dark current



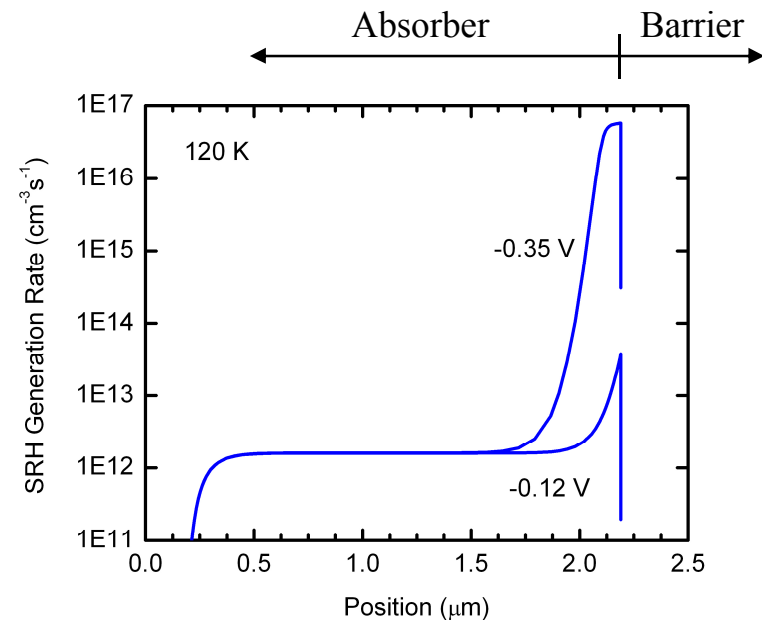
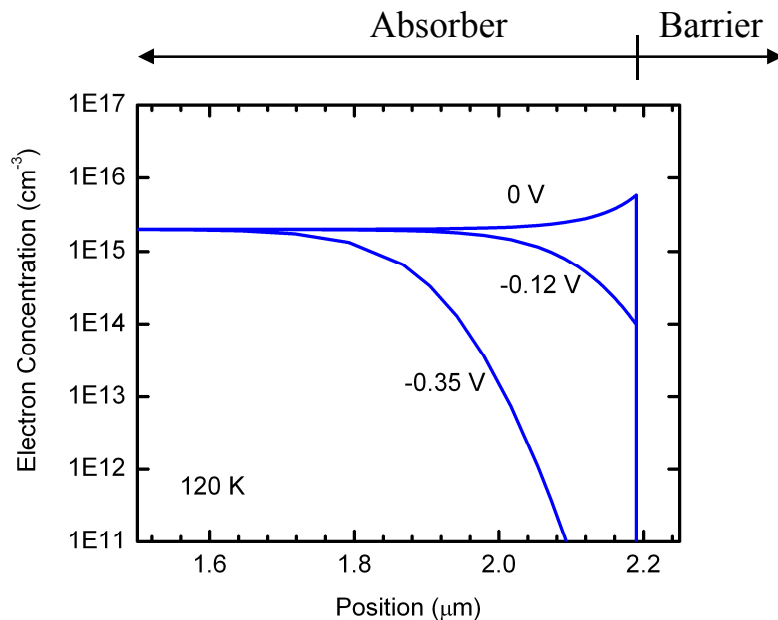
Full responsivity is achieved in Region 3

Current plateaus in Region 3, in contrast to high slope in experiment

As in experimental devices, T dependence of dark current is bias-dependent

- Suggests that depletion-region SRH dominates at -0.35 V (Region 2)
- Neutral absorber SRH (diffusion current) dominates at -0.12 V (Region 3)

# Spatial and bias dependence of nBn SRH generation rates



- Absorber accumulation layer exists at 0 bias
- Weak, thin depletion layer at -0.12 V
- Full, thin depletion layer at -0.35 V
- Depletion region SRH weak at -0.12 V
- Depletion region SRH rate saturates near -0.35 V

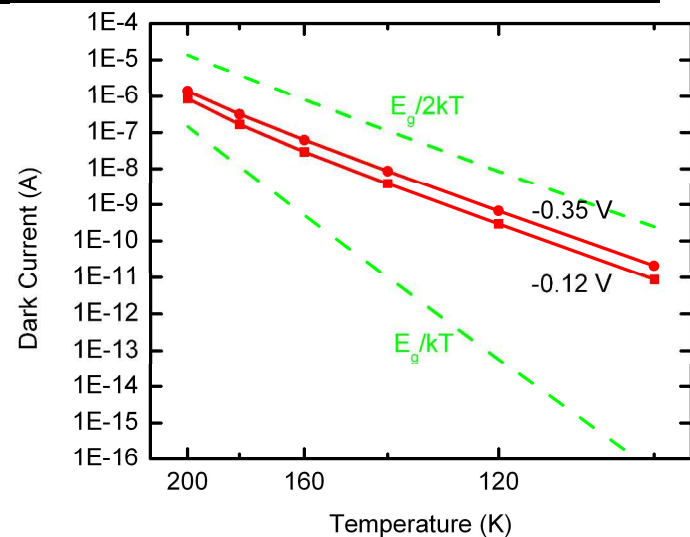
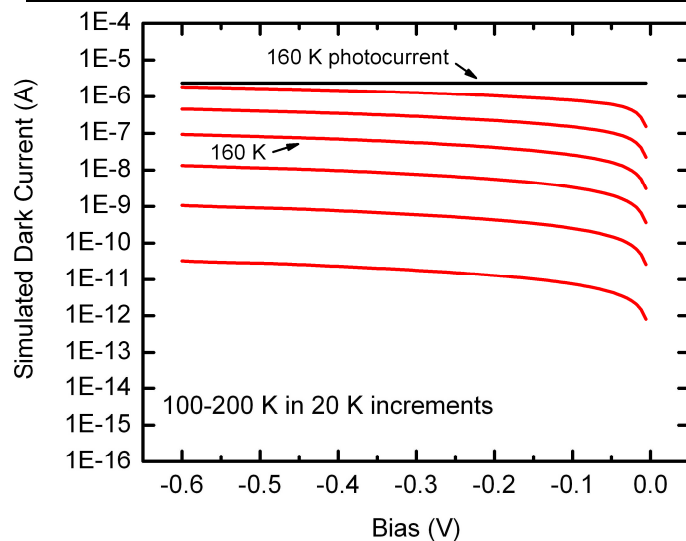
At bias of -0.12 V, which allows photocurrent collection, absorber has only weak depletion region

- Dark current generation dominated by SRH (diffusion current) in neutral absorber region

At bias of -0.35 V, a strong depletion region is formed

- Depletion region SRH dominates

# Simulated nBp dark current



Responsivity is flat across entire reverse bias range

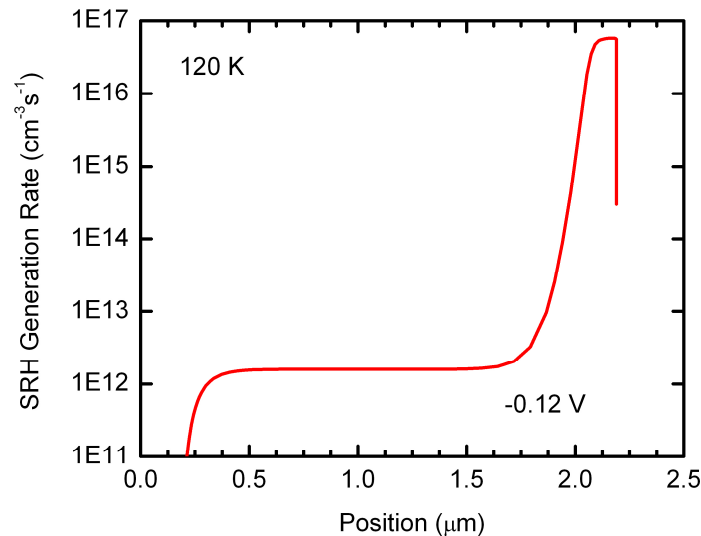
– Equal to maximum nBn responsivity

No “step” structure in I-V

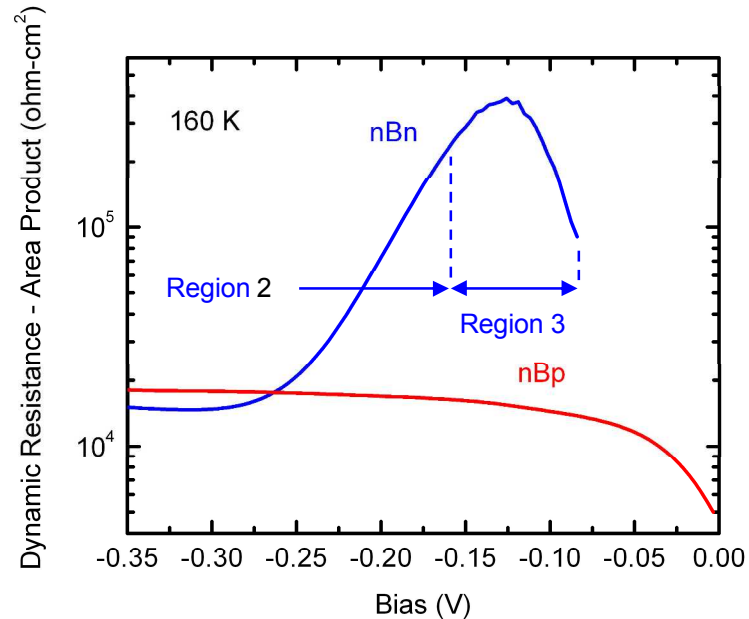
T dependence is  $E_g/2kT$  – like at both biases

Depletion region SRH at -0.12 V similar to nBn at -0.35 V

Characteristics very similar to simulated homojunction p-n

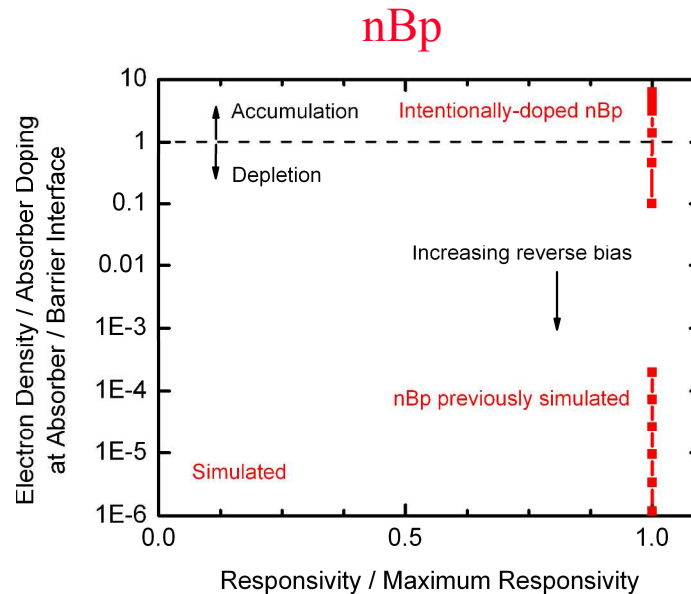
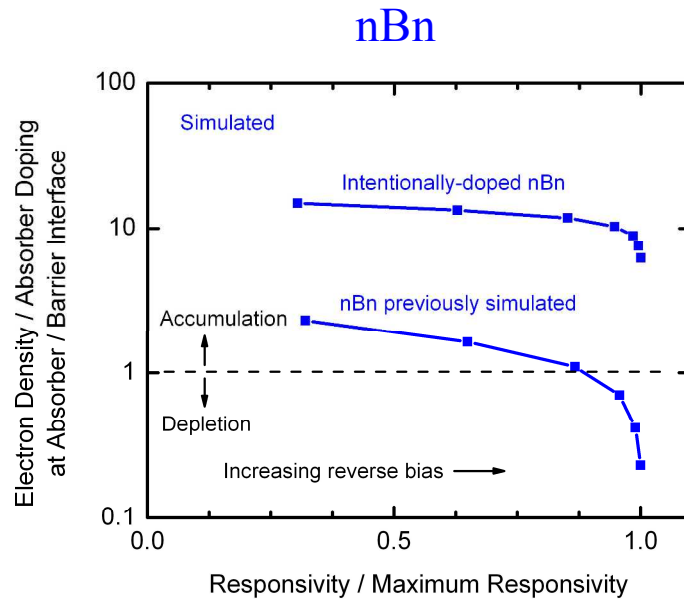


# Comparison of simulated dynamic resistances



At best bias point nBn dynamic resistance is  $\sim 20\times$  higher than nBp  
High dynamic resistance of nBn obtained in Region 3 (diffusion-current-dominated)  
Suggests that nBn is capable of having low Johnson noise

## Can high responsivity be achieved with *no* absorber depletion?



- With proper doping, high responsivity is possible in both nBn and nBp with no depletion
  - Differential resistance of doped nBp comparable to nBn
- **Performance of optimized nBp should be similar to optimized nBn**



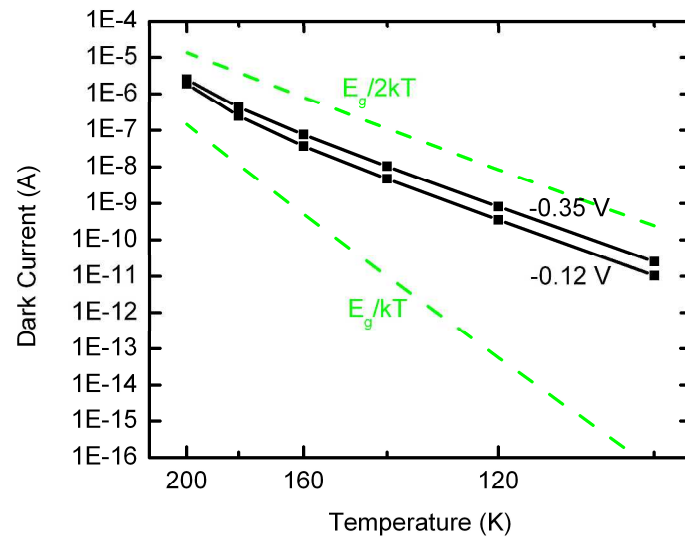


# Conclusions

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- **nBp structure is more generally applicable than nBn**
- **nBn and nBp mid-wave detectors fabricated with dark currents dominated by intrinsic sources (not sidewall leakage)**
- **Experimental characteristics of nBn and nBp qualitatively different**
  - **nBn exhibits bias region where diffusion current dominates at low T**
  - **nBp dark current dominated by depletion region SRH**
- **Simulation confirms observed behavior in both devices**
- **Characteristics of unoptimized nBp similar to convention p-n detector**
- **Differences in characteristics explained by larger nBp built-in potential**
- **Optimized nBn and nBp should have similar performance**
  - **Absence of parasitic sidewall conductance**
  - **Dark current dominated by absorber diffusion current**

# Simulated n-p homojunction dark current



Characteristics very similar to nBp – depletion region SRH dominates